FAIRCHILD

SEMICONDUCTOR®

BF240

NPN RF Transistor



1. Collector 2. Emitter 3. Base

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Absolute Maximum Ratings* $T_a=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	40	V
V _{CBO}	Collector-Base Voltage	40	V
V _{EBO}	Emitter-Base Voltage	4.0	V
I _C	Collector Current - Continuous	50	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1) These ratings are based on a maximum junction temperature of 150 degrees C.
2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

Electrical Characteristics $T_a=25^{\circ}C$ unless otherwise noted

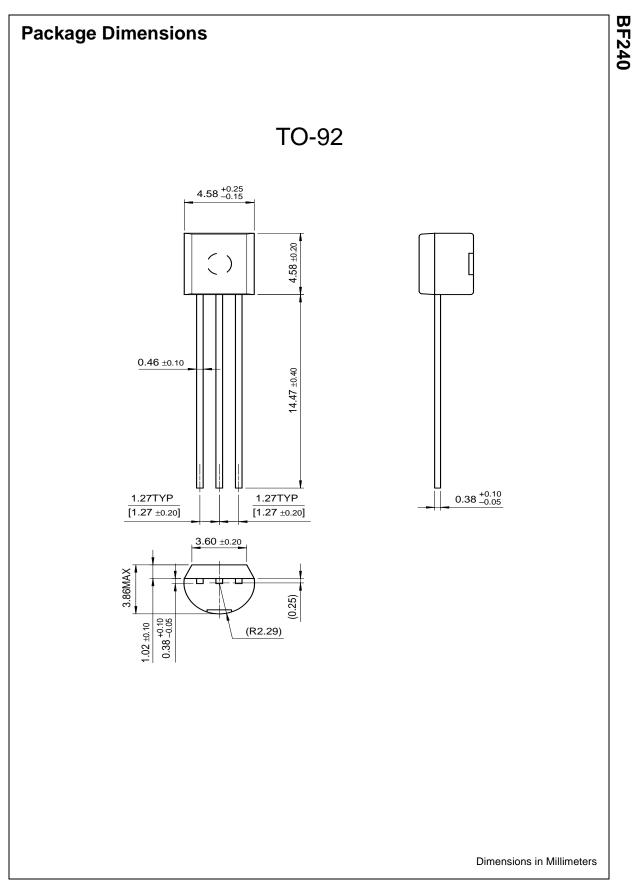
Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Characte	eristics	•		•	
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage *	$I_{\rm C} = 1.0 {\rm mA}, I_{\rm B} = 0$	40		V
V _{(BR)CBO}	Collector-Base BreakdownVoltage	$I_{\rm C} = 100\mu A, I_{\rm E} = 0$	40		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_{\rm E} = 10\mu A, I_{\rm C} = 0$	4.0		V
I _{CBO}	Collector Cut-off Current	$V_{CB} = 20V, I_E = 0$		100	nA
On Characte	eristics				
h _{FE}	DC Current Gain	$I_{\rm C} = 1$ mA, $V_{\rm CE} = 10$ V	65	225	
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_{\rm C} = 1$ mA, $I_{\rm B} = 0.1$ mA		0.65	V
V _{BE} (sat)	Base-Emitter Saturation Voltage	$I_{\rm C} = 1$ mA, $I_{\rm B} = 0.1$ mA		0.74	V
Small Signa	I Characteristics	•		•	
f _T	Current gain Bandwidth Product	$I_{C} = 7.0 \text{mA}, V_{CE} = 10 \text{V},$ f = 100MHz		1100	MHz
C _{re}	Common-Emitter Ruerse Transfer Capacitance	$V_{CB} = 10V, I_E = 0, f = 1.0MHz$		0.34	pF

* Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%

Thermal Characteristics TA=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
PD	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

BF240



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